Draft Nendica ICAID renewal

to extend Nendica beyond September 2021

* r06 (2021-07-09): updates proposed by Roger Marks, in yellow highlights, based on recents events
* r05 (2021-06-03): as agreed by Nendica for presubmittal to IEEE 802
* r04 (2021-06-02) clean version of r02, with changes accepted and minor changes (added date of IEEE 802 tutorial on CTF; highlighted TBD dates)
* r03 (2021-05-20) with changes as discussed at Nendica meeting of 2021-05-20
* r02 (2021-05-06) with changes proposes to address comments of Glenn Parsons
* r01 (2021-05-05) proposed by Roger Marks, as a simple extension without major changes, showing markups to ICCom-provided baseline
* r00 (2021-03-19) as provided by IEEE staff, including current Nendica content incorporated into current ICAID template

**IEEE 802 Network Enhancements for the Next Decade**

**Industry Connections Activity (Nendica)**

**Industry Connections Activity Initiation Document (ICAID)**

Version: 3.0, [date TBD] July 2021

IC17-001-03

**Instructions**

* Instructions on how to fill out this form are shown in red. It is recommended to leave the instructions in the final document and simply add the requested information where indicated.
* Shaded Text indicates a placeholder that should be replaced with information specific to this ICAID, and the shading removed.
* Completed forms, in Word format, or any questions should be sent to the IEEE Standards Association (IEEE SA) Industry Connections Committee (ICCom) Administrator at the following address: [industryconnections@ieee.org](mailto:industryconnections@ieee.org).
* The version number above, along with the date, may be used by the submitter to distinguish successive updates of this document. A separate, unique Industry Connections (IC) Activity Number will be assigned when the document is submitted to the ICCom Administrator.

1. **Contact**

Provide the name and contact information of the primary contact person for this IC activity. Affiliation is any entity that provides the person financial or other substantive support, for which the person may feel an obligation. If necessary, a second/alternate contact person’s information may also be provided.

**Name:** Roger Marks

**Email Address:** r.b.marks@ieee.org

**Employer:** none

**Affiliation:** EthAirNet Associates

IEEE collects personal data on this form, which is made publicly available, to allow communication by materially interested parties and with Activity Oversight Committee and Activity officers who are responsible for IEEE work items.

1. **Participation and Voting Model**

Specify whether this activity will be entity-based (participants are entities, which may have multiple representatives, one-entity-one-vote), or individual-based (participants represent themselves, one-person-one-vote).

Individual-Based

While operating as a subgroup under IEEE 802.1, any person attending a meeting may vote on all motions (including recommending approval of the deliverables). A vote is carried by 75% of those present and voting Approve or Disapprove.

1. **Purpose**

**3.1 Motivation and Goal**

Briefly explain the context and motivation for starting this IC activity, and the overall purpose or goal to be accomplished.

The goal of this activity is to document emerging requirements and directions for IEEE 802 networks, identify commonalities, gaps, and trends not currently addressed by IEEE 802 standards and projects, and facilitate building industry consensus towards proposals to initiate new standards development efforts. Encouraged topics include enhancements of IEEE 802 communication networks and vertical networks as well as enhanced cooperative functionality among existing IEEE standards in support of network integration. Topics concerning higher-layer applications related to new standards development in the IEEE 802.1 Working Group are also specifically expected and encouraged. Findings related to existing IEEE 802 standards and projects are forwarded to the responsible working groups for further considerations.

**3.2 Related Work**

Provide a brief comparison of this activity to existing, related efforts or standards of which you are aware (industry associations, consortia, standardization activities, etc.).

There are no known IEEE 802 based activities comparable to this Industry Connections activity proposal. The proposed activity addresses topics distinct from the IEEE 802.3 ‘New Ethernet Applications’ Industry Connections activity. It will cooperate when findings may benefit both activities.

**3.3 Previously Published Material**

Provide a list of any known previously published material intended for inclusion in the proposed deliverables of this activity.

None

**3.4 Potential Markets Served**

Indicate the main beneficiaries of this work, and what the potential impact might be.

IEEE 802 technologies are deployed in a huge number of market applications, which are exhibiting a growing diversity in terms of the features needed. Solutions spanning these different application spaces and feature requirements will be best addressed by leveraging common technology approaches. This activity will enable industry consensus building on the market/application requirements and identify gaps and trends not currently addressed by IEEE 802 standardization of new solutions, which will help to foster industry engagements in new study groups and standardization topics.

During the 2017-2021 initial terms of this IEEE 802 Nendica activity, three primary markets were addressed:

(1) Nendica’s Lossless Data Center Networks (LLDCN) Work Item led to publication by IEEE in August 2018 of “[IEEE 802 Nendica Report: The Lossless Network for Data Centers (ISBN 978‐1‐5044‐5102‐4)](https://mentor.ieee.org/802.1/dcn/18/1-18-0042-00-ICne.pdf).” An active project (IEEE P802.1Qcz, on Congestion Isolation) arose from the Work Item, and the resulting draft is currently in IEEE Standards Association Ballot. Resulting discussions, including those raised in a well-attended IEEE 802/IETF Data Center Workshop in Bangkok in November 2018, led to a followup Work Item, resulting in the June 2021 publication by IEEE of “[Intelligent Lossless Data Center Networks](https://mentor.ieee.org/802.1/dcn/20/1-21-0004-00.pdf)(ISBN:978-1-5044-7741-3).

(2) Nendica’s Flexible Factory IoT (FFIOT) Work Item has led to the publication by IEEE in April 2020 of “IEEE 802 Nendica Report: Flexible Factory IoT — Use Cases and Communication Requirements for Wired and Wireless Bridged Networks (ISBN 978-1-5044-6229-7).” Discussion stimulated in this Work Item led to the development of PAR P802.1Qdq.

(3) A Nendica Study Item on “Cut-Through Forwarding in Bridges and Bridged Networks” was initiated in March 2021 and developed the goal of preparing an IEEE 802 tutorial (7 July 2021) on the value of standardizing cut-through forwarding procedures within IEEE 802. The activity identified relevant markets in industrial networks, high-performance computing networks, and audio/video networks. Over 130 people attended.

**3.5 How will the activity benefit the IEEE, society, or humanity?**

The activity expects to continue to broadly identify new standardization requirements and stimulate new standardization activities.

1. **Estimated Timeframe**

Indicate approximately how long you expect this activity to operate to achieve its proposed results (e.g., time to completion of all deliverables).

**Expected Completion Date:**2023-09

IC activities are chartered for two years at a time. Activities are eligible for extension upon request and review by ICCom and the responsible committee of the IEEE SA Board of Governors. Should an extension be required, please notify the ICCom Administrator prior to the two-year mark.

1. **Proposed Deliverables**

Outline the anticipated deliverables and output from this IC activity, such as documents (e.g., white papers, reports), proposals for standards, conferences and workshops, databases, computer code, etc., and indicate the expected timeframe for each.

Deliverables will be of two types:

* Records of the meetings, including minutes and supporting documents, some of which may be prepared for delivery to other venues for purposes such as encouraging interest and participation
* A set of reports and other consensus outputs documenting the findings of the IC activity, with recommendations regarding overviews of current industry practice and trends, new standardization topics, documentation of use cases and user needs for those topics, and proposed organizational approaches to ensure effective participation from user communities

**5.1  Open Source Software Development**

*Indicate whether this IC Activity will develop or incorporate open source software in the deliverables. All contributions of open source software for use in Industry Connections activities shall be accompanied by an approved IEEE Contributor License Agreement (CLA) appropriate for the open source license under which the Work Product will be made available. CLAs, once accepted, are irrevocable. Industry Connections Activities shall comply with the IEEE SA open source policies and procedures and use the IEEE SA open source platform for development of open source software. Information on IEEE SA Open can be found at* [*https://saopen.ieee.org/*](https://saopen.ieee.org/)*.*

Will the activity develop or incorporate open source software (either normatively or informatively) in the deliverables?: No

1. **Funding Requirements**

Outline any contracted services or other expenses that are currently anticipated, beyond the basic support services provided to all IC activities. Indicate how those funds are expected to be obtained (e.g., through participant fees, sponsorships, government or other grants, etc.). Activities needing substantial funding may require additional reviews and approvals beyond ICCom.

None.

1. **Management and Procedures**

**7.1 Activity Oversight Committee**

Indicate whether an IEEE committee of some form (e.g., a Standards committee) has agreed to oversee this activity and its procedures.

**Has an IEEE committee agreed to oversee this activity?: Yes**

If yes, indicate the IEEE committee’s name and its chair’s contact information.

**IEEE Committee Name:** IEEE 802 LAN/MAN Standards Committee

**Chair’s Name:** Paul Nikolich

**Chair’s Email Address:** [p.nikolich@ieee.org](mailto:p.nikolich@ieee.org)

**Chair’s Phone:**

This activity operates as a subgroup under the IEEE 802.1 Working Group.

**Working Group Chair:** IEEE 802.1 Higher Layer LAN Protocols Working Group

**Chair’s Name:** Glenn Parsons

**Chair’s Email Address**: [glenn.parsons@ericsson.com](mailto:glenn.parsons@ericsson.com)

**Chair’s Phone:**

Additional IEEE committee information, if any. Please indicate if you are including a letter of support from the IEEE Committee that will oversee this activity.

IEEE collects personal data on this form, which is made publicly available, to allow communication by materially interested parties and with Activity Oversight Committee and Activity officers who are responsible for IEEE work items.

**7.2 Activity Management**

If no Activity Oversight Committee has been identified in 7.1 above, indicate how this activity will manage itself on a day-to-day basis (e.g., executive committee, officers, etc).

N/A

**7.3 Procedures**

Indicate what documented procedures will be used to guide the operations of this activity; either (a) modified baseline *Industry Connections Activity Policies and Procedures,* (b) Standards Committee policies and procedures accepted by the IEEE SA Standards

Board, or (c) Working Group policies and procedures accepted by the Working Group’s Standards Committee. If option (a) is chosen, then ICCom review and approval of the P&P is required. If option (b) or (c) is chosen, then ICCom approval of the use of the P&P is required.

IEEE 802 Policies & Procedures

IEEE 802 LMSC Operations Manual

IEEE 802 Working Group Policies & Procedures

IEEE 802 Nendica Report Development Process

<https://1.ieee802.org/802-nendica/ieee-802-nendica-procedures>

1. **Participants**

**8.1 Stakeholder Communities**

Indicate the stakeholder communities (the types of companies or other entities, or the different groups of individuals) that are expected to be interested in this IC activity, and will be invited to participate.

Stakeholders identified to date include but are not limited to: users and producers of systems and components for networking systems, data center networks, high performance computing, cloud computing, telecommunications carriers, automotive, intelligent transport systems, Internet of Things (IoT), factory automation, and industrial applications.

**8.2 Expected Number of Participants**

Indicate the approximate number of entities (if entity-based) or individuals (if individual-based) expected to be actively involved in this activity.

30 individuals

**8.3 Initial Participants**

Provide a number of the entities or individuals that will be participating from the outset. It is recommended there be at least three initial participants for an entity-based activity, or five initial participants (each with a different affiliation) for an individual-based activity.

Use the following table for an entity-based activity:

|  |  |  |
| --- | --- | --- |
| **Entity** | **Primary Contact** | **Additional Representatives** |
| Entity Name | Contact Name | Name |
|  |  |  |

Use the following table for an individual-based activity:

|  |  |  |  |
| --- | --- | --- | --- |
| **Individual** | **Contact Information** | **Employer** | **Affiliation** |
| Roger Marks |  | EthAirNet Associates | EthAirNet Associates |
| Glenn Parsons |  | Ericsson | Ericsson |
| Paul Congdon |  | Tallac Networks | Huawei |
| Jessy Rouyer |  |  | Nokia |
| Johannes Specht |  |  | Analog Devices, Inc.; Mitsubishi Electric Corporation; Phoenix Contact GmbH & Co. KG; PROFIBUS Nutzerorganisation e.V.; Siemens AG; Texas Instruments, Inc. |
| Lily Lv |  |  | Huawei Technologies Co., Ltd |
| Ludwig Winkel |  |  | PNO e.V. |
| Hiroki Nakano |  | CAHI Corporation | Kyoto University; National Institute of Information and  Communications Technology (Japan) |

Additional rows upon request.